

General Description

The WSF3040 is the highest performance trench N-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF3040 meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

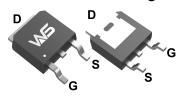
Product Summery

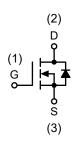
BVDSS	RDSON	ID
30V	10mΩ	43A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

TO-252-2L Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	43	Α
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹	30	Α
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	11	Α
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	9	Α
I _{DM}	Pulsed Drain Current ²	112	А
EAS	Single Pulse Avalanche Energy ³	53	mJ
I _{AS}	Avalanche Current	22	Α
P _D @T _C =25℃	Total Power Dissipation⁴	37.5	W
P _D @T _A =25°C	Total Power Dissipation ⁴	2	W
T _{STG}	Storage Temperature Range	-55 to 175	$^{\circ}$
T_J	Operating Junction Temperature Range	-55 to 175	$^{\circ}$

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{0JA}	Thermal Resistance Junction-Ambient ¹		62	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case ¹		4	°C/W



N-Ch MOSFET

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V	
$\triangle BV_{DSS}/\triangle T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25 $^{\circ}{\mathbb{C}}$, I _D =1mA		0.0193		V/°C	
В	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =30A		10	12		
R _{DS(ON)}		V _{GS} =4.5V , I _D =15A		15	18	mΩ	
V _{GS(th)}	Gate Threshold Voltage)/ -\/ -250A	1.2	1.5	2.5	V	
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250uA$		-3.97		mV/℃	
	Drain Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25℃			1		
I _{DSS}	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =55℃			5	uA	
I _{GSS}	Gate-Source Leakage Current	V_{GS} = $\pm 20V$, V_{DS} = $0V$			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =30A		34		S	
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.8	3.6	Ω	
Qg	Total Gate Charge (4.5V)			9.8	13.7		
Q _{gs}	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =15A		4.2	5.88	nC	
Q_gd	Gate-Drain Charge			3.6	5.0		
$T_{d(on)}$	Turn-On Delay Time			5	8.0		
Tr	Rise Time	V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω		8	14		
T _{d(off)}	Turn-Off Delay Time	I _D =15A		4	8	ns	
T _f	Fall Time			31	62		
C _{iss}	Input Capacitance			940	1316		
C _{oss}	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		131	183	pF	
C _{rss}	Reverse Transfer Capacitance			109	153		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy ⁵	V _{DD} =25V , L=0.1mH , I _{AS} =15A	24.6			mJ

Diode Characteristics

Symbol	Parameter	Conditions		Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}	V =V =0V Force Current			15	Α
I _{SM}	Pulsed Source Current ^{2,6}	V _G =V _D =0V , Force Current			112	Α
V_{SD}	Diode Forward Voltage ²	V_{GS} =0V , I_{S} =1A , T_{J} =25 $^{\circ}$ C			1	V
t _{rr}	Reverse Recovery Time	lF=30A,dI/dt=100A/μs,Tյ=25℃		8.5		nS
Qrr	Reverse Recovery Charge	-11-30A , αι/αι-100A/μs , 13-23 C		2.2		nC

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, t<10 sec.
- 2.The data tested by pulsed , pulse width $\,\leq\,300\text{us}$, duty cycle $\,\leq\,2\%$
- 3.The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V,L=0.1mH, I_{AS} =15A
- 4.The power dissipation is limited by 175 $^{\circ}\mathrm{C}\,$ junction temperature
- 5.The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.





Typical Characteristics

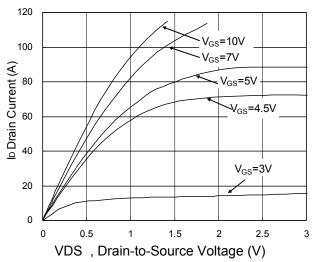


Fig.1 Typical Output Characteristics

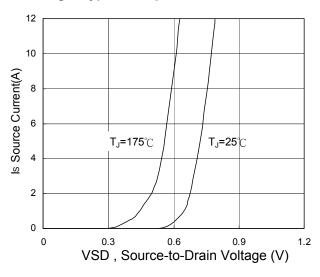
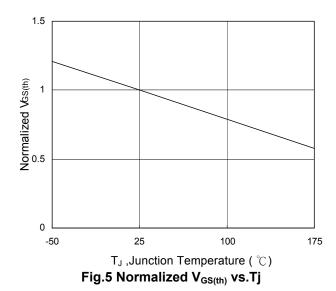


Fig.3 Forward Characteristics of Reverse



18 | I_D=30A | I_D=3

Fig.2 On-Resistance vs. G-S Voltage

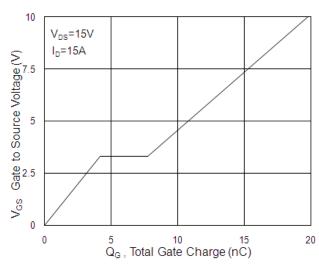


Fig.4 Gate-Charge Characteristics

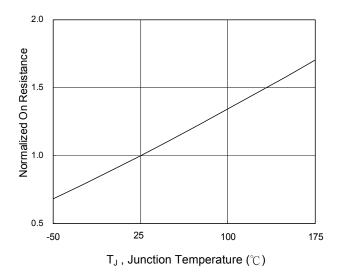
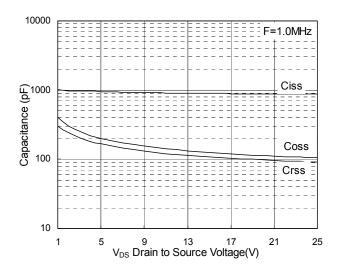


Fig.6 Normalized R_{DSON} vs. T_J



N-Ch MOSFET



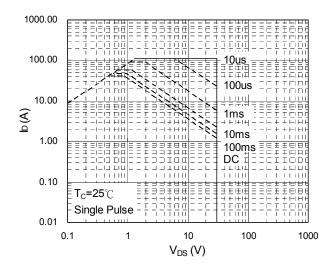


Fig.7 Capacitance

Fig.8 Safe Operating Area

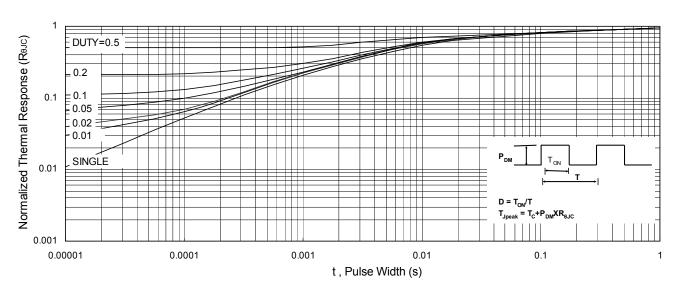


Fig.9 Normalized Maximum Transient Thermal Impedance

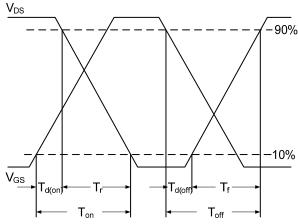


Fig.10 Switching Time Waveform

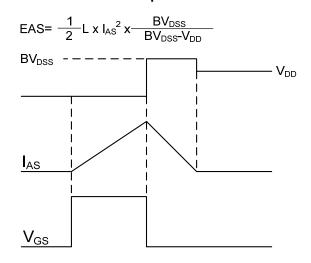
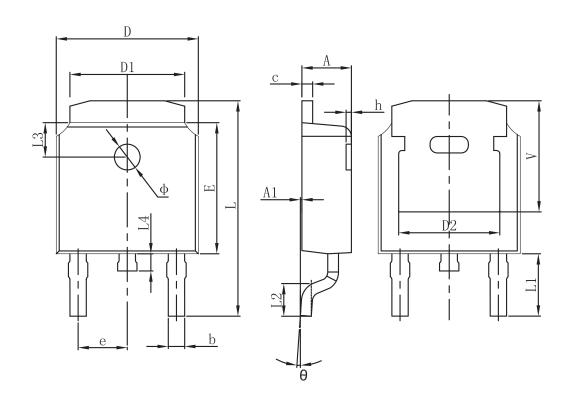


Fig.11 Unclamped Inductive Switching Waveform



Packaging information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.635	0.770	0.025	0.030	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830	REF.	0.190 REF.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.712	10.312	0.382	0.406	
L1	2.900 REF.		0.114	REF.	
L2	1.400	1.700	0.055	0.067	
L3	1.600	REF.	0.063 REF.		
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.250	REF.	0.207 REF.		



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